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Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

Applications of Embedded - CPLDs

Details

| | |
|---------------------------------|---|
| Product Status | Obsolete |
| Programmable Type | In System Programmable |
| Delay Time tpd(1) Max | 10 ns |
| Voltage Supply - Internal | 4.5V ~ 5.5V |
| Number of Logic Elements/Blocks | 8 |
| Number of Macrocells | 128 |
| Number of Gates | 2500 |
| Number of I/O | 68 |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 84-LCC (J-Lead) |
| Supplier Device Package | 84-PLCC (29.31x29.31) |
| Purchase URL | https://www.e-xfl.com/product-detail/intel/epm7128sli84-10 |

- Additional design entry and simulation support provided by EDIF 2.0.0 and 3.0.0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, and VeriBest
- Programming support
 - Altera's Master Programming Unit (MPU) and programming hardware from third-party manufacturers program all MAX 7000 devices
 - The BitBlaster™ serial download cable, ByteBlasterMV™ parallel port download cable, and MasterBlaster™ serial/universal serial bus (USB) download cable program MAX 7000S devices

General Description

The MAX 7000 family of high-density, high-performance PLDs is based on Altera's second-generation MAX architecture. Fabricated with advanced CMOS technology, the EEPROM-based MAX 7000 family provides 600 to 5,000 usable gates, ISP, pin-to-pin delays as fast as 5 ns, and counter speeds of up to 175.4 MHz. MAX 7000S devices in the -5, -6, -7, and -10 speed grades as well as MAX 7000 and MAX 7000E devices in -5, -6, -7, -10P, and -12P speed grades comply with the PCI Special Interest Group (PCI SIG) *PCI Local Bus Specification, Revision 2.2*. See [Table 3](#) for available speed grades.

Table 3. MAX 7000 Speed Grades

| Device | Speed Grade | | | | | | | | | |
|----------|-------------|----|----|------|-----|------|-----|-----|------|-----|
| | -5 | -6 | -7 | -10P | -10 | -12P | -12 | -15 | -15T | -20 |
| EPM7032 | | ✓ | ✓ | | ✓ | | ✓ | ✓ | ✓ | |
| EPM7032S | ✓ | ✓ | ✓ | | ✓ | | | | | |
| EPM7064 | | ✓ | ✓ | | ✓ | | ✓ | ✓ | | |
| EPM7064S | ✓ | ✓ | ✓ | | ✓ | | | | | |
| EPM7096 | | | ✓ | | ✓ | | ✓ | ✓ | | |
| EPM7128E | | | ✓ | ✓ | ✓ | | ✓ | ✓ | | ✓ |
| EPM7128S | | ✓ | ✓ | | ✓ | | | ✓ | | |
| EPM7160E | | | | ✓ | ✓ | | ✓ | ✓ | | ✓ |
| EPM7160S | | ✓ | ✓ | | ✓ | | | ✓ | | |
| EPM7192E | | | | | | ✓ | ✓ | ✓ | | ✓ |
| EPM7192S | | | ✓ | | ✓ | | | ✓ | | |
| EPM7256E | | | | | | ✓ | ✓ | ✓ | | ✓ |
| EPM7256S | | | ✓ | | ✓ | | | ✓ | | |

The MAX 7000 architecture includes four dedicated inputs that can be used as general-purpose inputs or as high-speed, global control signals (clock, clear, and two output enable signals) for each macrocell and I/O pin. Figure 1 shows the architecture of EPM7032, EPM7064, and EPM7096 devices.

Figure 1. EPM7032, EPM7064 & EPM7096 Device Block Diagram

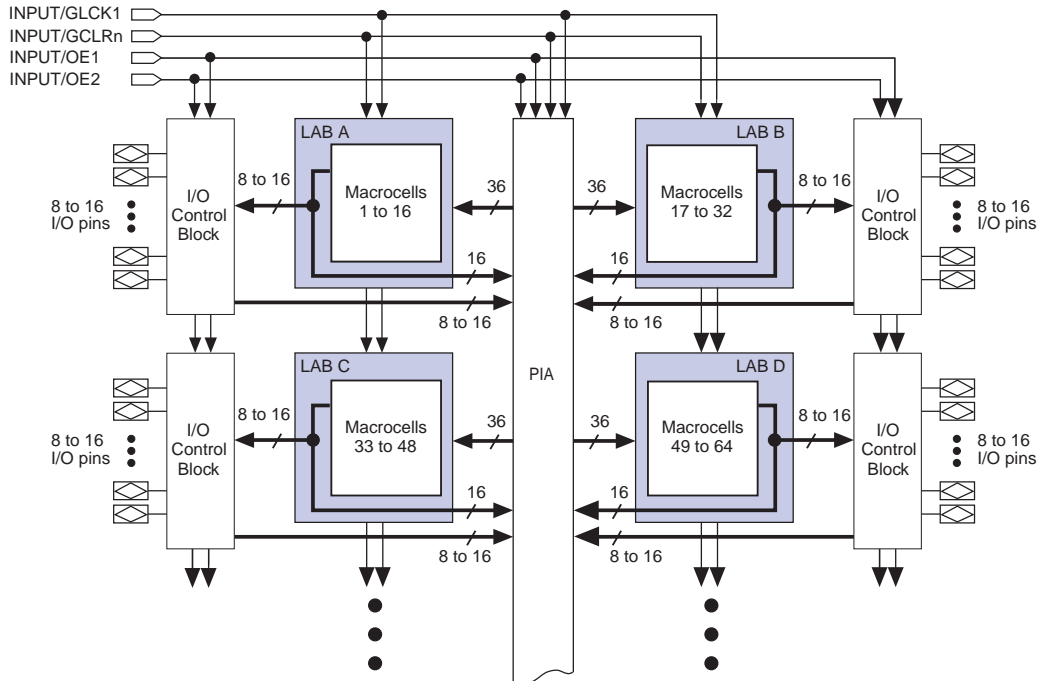
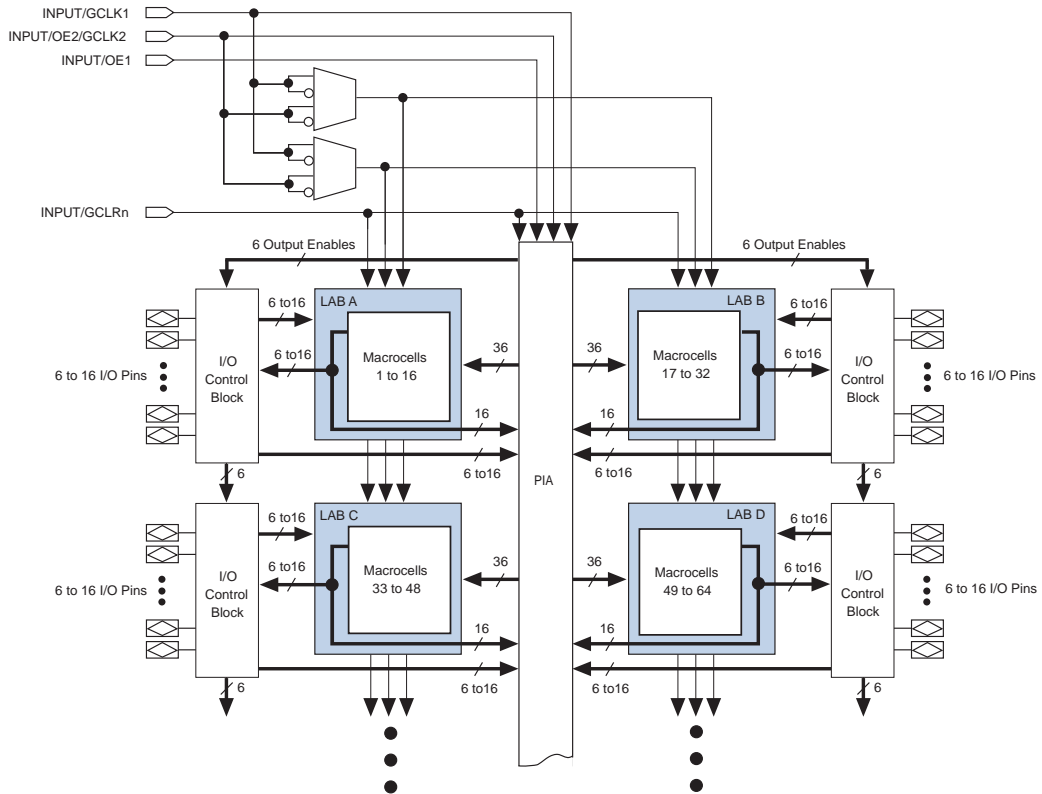


Figure 2 shows the architecture of MAX 7000E and MAX 7000S devices.

Figure 2. MAX 7000E & MAX 7000S Device Block Diagram



Logic Array Blocks

The MAX 7000 device architecture is based on the linking of high-performance, flexible, logic array modules called logic array blocks (LABs). LABs consist of 16-macrocell arrays, as shown in Figures 1 and 2. Multiple LABs are linked together via the programmable interconnect array (PIA), a global bus that is fed by all dedicated inputs, I/O pins, and macrocells.

Each LAB is fed by the following signals:

- 36 signals from the PIA that are used for general logic inputs
- Global controls that are used for secondary register functions
- Direct input paths from I/O pins to the registers that are used for fast setup times for MAX 7000E and MAX 7000S devices

Macrocells

The MAX 7000 macrocell can be individually configured for either sequential or combinatorial logic operation. The macrocell consists of three functional blocks: the logic array, the product-term select matrix, and the programmable register. The macrocell of EPM7032, EPM7064, and EPM7096 devices is shown in Figure 3.

Figure 3. EPM7032, EPM7064 & EPM7096 Device Macrocell

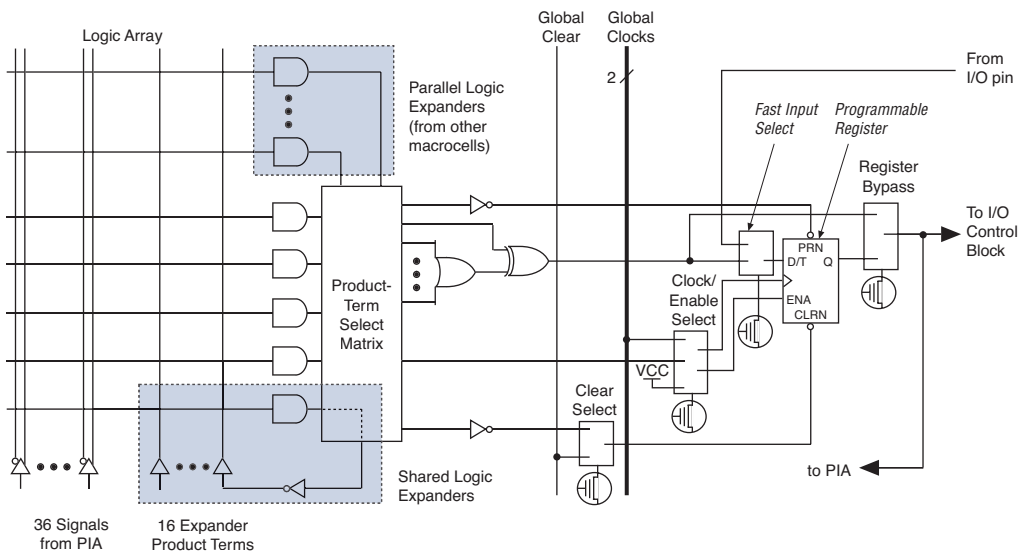
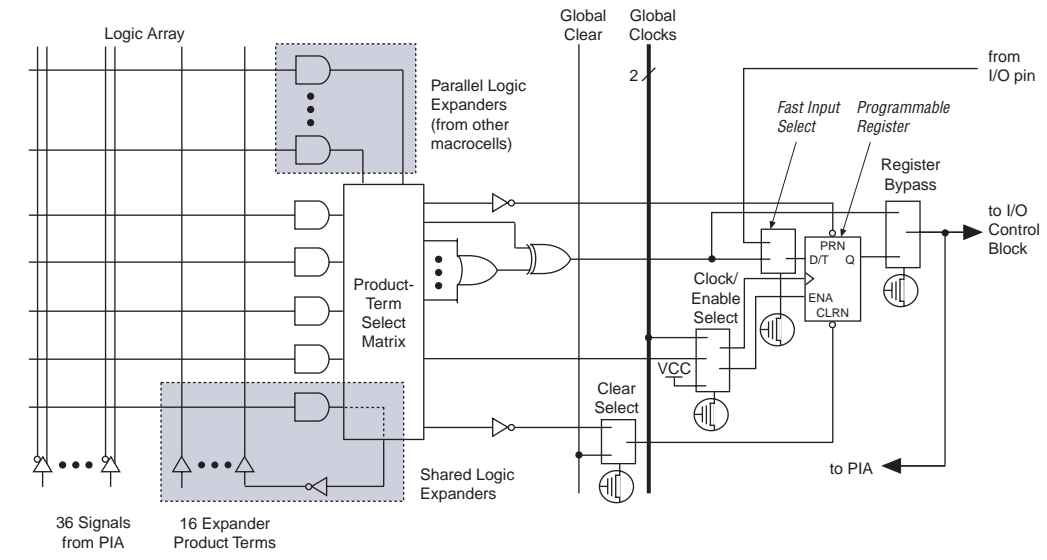


Figure 4 shows a MAX 7000E and MAX 7000S device macrocell.

Figure 4. MAX 7000E & MAX 7000S Device Macrocell



Combinatorial logic is implemented in the logic array, which provides five product terms per macrocell. The product-term select matrix allocates these product terms for use as either primary logic inputs (to the OR and XOR gates) to implement combinatorial functions, or as secondary inputs to the macrocell's register clear, preset, clock, and clock enable control functions. Two kinds of expander product terms ("expanders") are available to supplement macrocell logic resources:

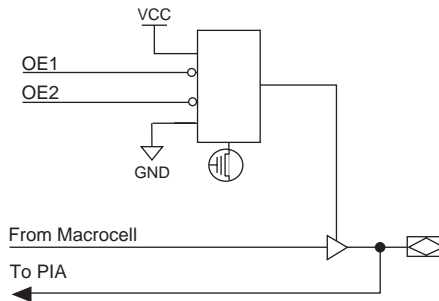
- Shareable expanders, which are inverted product terms that are fed back into the logic array
- Parallel expanders, which are product terms borrowed from adjacent macrocells

The Altera development system automatically optimizes product-term allocation according to the logic requirements of the design.

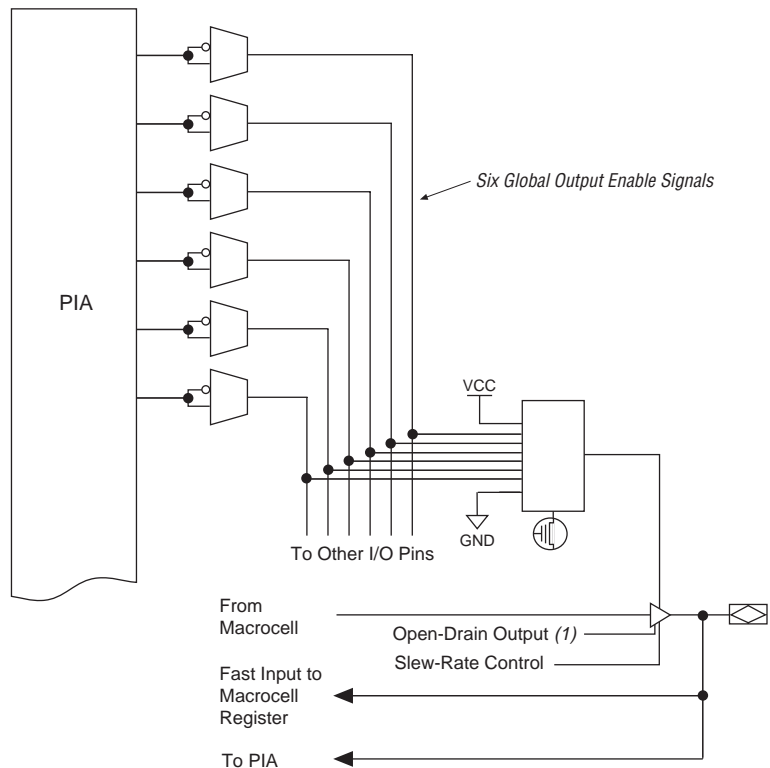
For registered functions, each macrocell flipflop can be individually programmed to implement D, T, JK, or SR operation with programmable clock control. The flipflop can be bypassed for combinatorial operation. During design entry, the designer specifies the desired flipflop type; the Altera development software then selects the most efficient flipflop operation for each registered function to optimize resource utilization.

Figure 8. I/O Control Block of MAX 7000 Devices

EPM7032, EPM7064 & EPM7096 Devices



MAX 7000E & MAX 7000S Devices



Note:

- (1) The open-drain output option is available only in MAX 7000S devices.

When the tri-state buffer control is connected to ground, the output is tri-stated (high impedance) and the I/O pin can be used as a dedicated input. When the tri-state buffer control is connected to V_{CC} , the output is enabled.

The MAX 7000 architecture provides dual I/O feedback, in which macrocell and pin feedbacks are independent. When an I/O pin is configured as an input, the associated macrocell can be used for buried logic.

In-System Programmability (ISP)

MAX 7000S devices are in-system programmable via an industry-standard 4-pin Joint Test Action Group (JTAG) interface (IEEE Std. 1149.1-1990). ISP allows quick, efficient iterations during design development and debugging cycles. The MAX 7000S architecture internally generates the high programming voltage required to program EEPROM cells, allowing in-system programming with only a single 5.0 V power supply. During in-system programming, the I/O pins are tri-stated and pulled-up to eliminate board conflicts. The pull-up value is nominally 50 k Ω .

ISP simplifies the manufacturing flow by allowing devices to be mounted on a printed circuit board with standard in-circuit test equipment before they are programmed. MAX 7000S devices can be programmed by downloading the information via in-circuit testers (ICT), embedded processors, or the Altera MasterBlaster, ByteBlasterMV, ByteBlaster, BitBlaster download cables. (The ByteBlaster cable is obsolete and is replaced by the ByteBlasterMV cable, which can program and configure 2.5-V, 3.3-V, and 5.0-V devices.) Programming the devices after they are placed on the board eliminates lead damage on high-pin-count packages (e.g., QFP packages) due to device handling and allows devices to be reprogrammed after a system has already shipped to the field. For example, product upgrades can be performed in the field via software or modem.

In-system programming can be accomplished with either an adaptive or constant algorithm. An adaptive algorithm reads information from the unit and adapts subsequent programming steps to achieve the fastest possible programming time for that unit. Because some in-circuit testers cannot support an adaptive algorithm, Altera offers devices tested with a constant algorithm. Devices tested to the constant algorithm have an "F" suffix in the ordering code.

The JamTM Standard Test and Programming Language (STAPL) can be used to program MAX 7000S devices with in-circuit testers, PCs, or embedded processor.

By using an external 5.0-V pull-up resistor, output pins on MAX 7000S devices can be set to meet 5.0-V CMOS input voltages. When V_{CCIO} is 3.3 V, setting the open drain option will turn off the output pull-up transistor, allowing the external pull-up resistor to pull the output high enough to meet 5.0-V CMOS input voltages. When V_{CCIO} is 5.0 V, setting the output drain option is not necessary because the pull-up transistor will already turn off when the pin exceeds approximately 3.8 V, allowing the external pull-up resistor to pull the output high enough to meet 5.0-V CMOS input voltages.

Slew-Rate Control

The output buffer for each MAX 7000E and MAX 7000S I/O pin has an adjustable output slew rate that can be configured for low-noise or high-speed performance. A faster slew rate provides high-speed transitions for high-performance systems. However, these fast transitions may introduce noise transients into the system. A slow slew rate reduces system noise, but adds a nominal delay of 4 to 5 ns. In MAX 7000E devices, when the Turbo Bit is turned off, the slew rate is set for low noise performance. For MAX 7000S devices, each I/O pin has an individual EEPROM bit that controls the slew rate, allowing designers to specify the slew rate on a pin-by-pin basis.

Programming with External Hardware

MAX 7000 devices can be programmed on Windows-based PCs with the Altera Logic Programmer card, the Master Programming Unit (MPU), and the appropriate device adapter. The MPU performs a continuity check to ensure adequate electrical contact between the adapter and the device.



For more information, see the [*Altera Programming Hardware Data Sheet*](#).

The Altera development system can use text- or waveform-format test vectors created with the Text Editor or Waveform Editor to test the programmed device. For added design verification, designers can perform functional testing to compare the functional behavior of a MAX 7000 device with the results of simulation. Moreover, Data I/O, BP Microsystems, and other programming hardware manufacturers also provide programming support for Altera devices.



For more information, see the [*Programming Hardware Manufacturers*](#).

Figure 9 shows the timing requirements for the JTAG signals.

Figure 9. MAX 7000 JTAG Waveforms

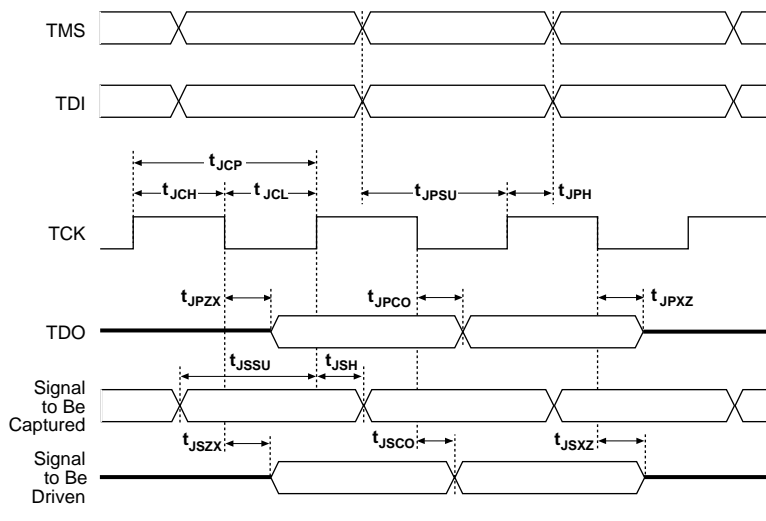


Table 12 shows the JTAG timing parameters and values for MAX 7000S devices.

| Table 12. JTAG Timing Parameters & Values for MAX 7000S Devices | | | | |
|--|--|------------|------------|-------------|
| Symbol | Parameter | Min | Max | Unit |
| t_{JCP} | TCK clock period | 100 | | ns |
| t_{JCH} | TCK clock high time | 50 | | ns |
| t_{JCL} | TCK clock low time | 50 | | ns |
| t_{JPSU} | JTAG port setup time | 20 | | ns |
| t_{JPH} | JTAG port hold time | 45 | | ns |
| t_{JPCO} | JTAG port clock to output | | 25 | ns |
| t_{JPZX} | JTAG port high impedance to valid output | | 25 | ns |
| t_{JPXZ} | JTAG port valid output to high impedance | | 25 | ns |
| t_{JSSU} | Capture register setup time | 20 | | ns |
| t_{JSH} | Capture register hold time | 45 | | ns |
| t_{JSCO} | Update register clock to output | | 25 | ns |
| t_{JSZX} | Update register high impedance to valid output | | 25 | ns |
| t_{JSXZ} | Update register valid output to high impedance | | 25 | ns |



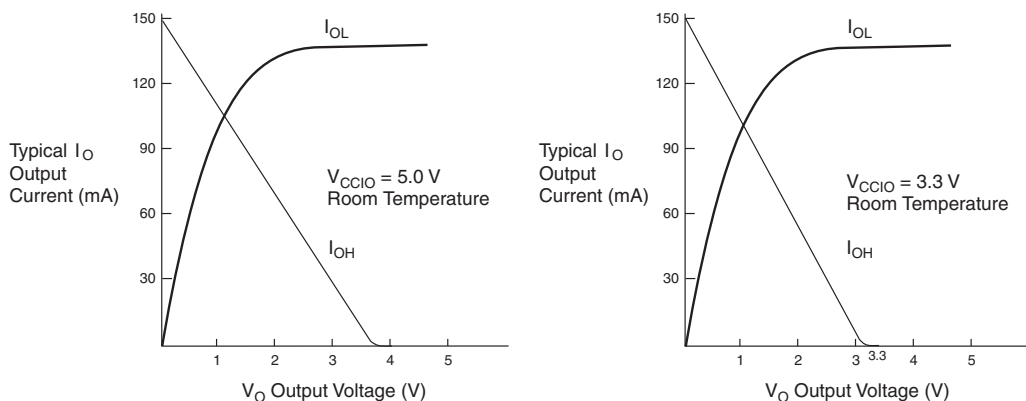
For more information, see [Application Note 39 \(IEEE 1149.1 \(JTAG\) Boundary-Scan Testing in Altera Devices\)](#).

Notes to tables:

- (1) See the *Operating Requirements for Altera Devices Data Sheet*.
- (2) Minimum DC input voltage on I/O pins is -0.5 V and on 4 dedicated input pins is -0.3 V. During transitions, the inputs may undershoot to -2.0 V or overshoot to 7.0 V for input currents less than 100 mA and periods shorter than 20 ns.
- (3) Numbers in parentheses are for industrial-temperature-range devices.
- (4) V_{CC} must rise monotonically.
- (5) The POR time for all 7000S devices does not exceed 300 μ s. The sufficient V_{CCINT} voltage level for POR is 4.5 V. The device is fully initialized within the POR time after V_{CCINT} reaches the sufficient POR voltage level.
- (6) 3.3 -V I/O operation is not available for 44-pin packages.
- (7) The V_{CCISP} parameter applies only to MAX 7000S devices.
- (8) During in-system programming, the minimum DC input voltage is -0.3 V.
- (9) These values are specified under the MAX 7000 recommended operating conditions in [Table 14 on page 26](#).
- (10) The parameter is measured with 50% of the outputs each sourcing the specified current. The I_{OH} parameter refers to high-level TTL or CMOS output current.
- (11) The parameter is measured with 50% of the outputs each sinking the specified current. The I_{OL} parameter refers to low-level TTL, PCI, or CMOS output current.
- (12) When the JTAG interface is enabled in MAX 7000S devices, the input leakage current on the JTAG pins is typically -60 μ A.
- (13) Capacitance is measured at 25° C and is sample-tested only. The $\text{OE}1$ pin has a maximum capacitance of 20 pF.

Figure 11 shows the typical output drive characteristics of MAX 7000 devices.

Figure 11. Output Drive Characteristics of 5.0-V MAX 7000 Devices



Timing Model

MAX 7000 device timing can be analyzed with the Altera software, with a variety of popular industry-standard EDA simulators and timing analyzers, or with the timing model shown in [Figure 12](#). MAX 7000 devices have fixed internal delays that enable the designer to determine the worst-case timing of any design. The Altera software provides timing simulation, point-to-point delay prediction, and detailed timing analysis for a device-wide performance evaluation.

Tables 19 through 26 show the MAX 7000 and MAX 7000E AC operating conditions.

Table 19. MAX 7000 & MAX 7000E External Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | -6 Speed Grade | | -7 Speed Grade | | Unit |
|------------|--|----------------|----------------|-----|----------------|-----|------|
| | | | Min | Max | Min | Max | |
| t_{PD1} | Input to non-registered output | C1 = 35 pF | | 6.0 | | 7.5 | ns |
| t_{PD2} | I/O input to non-registered output | C1 = 35 pF | | 6.0 | | 7.5 | ns |
| t_{SU} | Global clock setup time | | 5.0 | | 6.0 | | ns |
| t_H | Global clock hold time | | 0.0 | | 0.0 | | ns |
| t_{FSU} | Global clock setup time of fast input | (2) | 2.5 | | 3.0 | | ns |
| t_{FH} | Global clock hold time of fast input | (2) | 0.5 | | 0.5 | | ns |
| t_{CO1} | Global clock to output delay | C1 = 35 pF | | 4.0 | | 4.5 | ns |
| t_{CH} | Global clock high time | | 2.5 | | 3.0 | | ns |
| t_{CL} | Global clock low time | | 2.5 | | 3.0 | | ns |
| t_{ASU} | Array clock setup time | | 2.5 | | 3.0 | | ns |
| t_{AH} | Array clock hold time | | 2.0 | | 2.0 | | ns |
| t_{ACO1} | Array clock to output delay | C1 = 35 pF | | 6.5 | | 7.5 | ns |
| t_{ACH} | Array clock high time | | 3.0 | | 3.0 | | ns |
| t_{ACL} | Array clock low time | | 3.0 | | 3.0 | | ns |
| t_{CPPW} | Minimum pulse width for clear and preset | (3) | 3.0 | | 3.0 | | ns |
| t_{ODH} | Output data hold time after clock | C1 = 35 pF (4) | 1.0 | | 1.0 | | ns |
| t_{CNT} | Minimum global clock period | | | 6.6 | | 8.0 | ns |
| f_{CNT} | Maximum internal global clock frequency | (5) | 151.5 | | 125.0 | | MHz |
| t_{ACNT} | Minimum array clock period | | | 6.6 | | 8.0 | ns |
| f_{ACNT} | Maximum internal array clock frequency | (5) | 151.5 | | 125.0 | | MHz |
| f_{MAX} | Maximum clock frequency | (6) | 200 | | 166.7 | | MHz |

Table 26. MAX 7000 & MAX 7000E Internal Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | Unit |
|------------|---|-------------------------|-------------|------|------|------|-----|------|------|
| | | | -15 | | -15T | | -20 | | |
| | | | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 2.0 | | 2.0 | | 3.0 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 2.0 | | 2.0 | | 3.0 | ns |
| t_{FIN} | Fast input delay | (2) | | 2.0 | | — | | 4.0 | ns |
| t_{SEXP} | Shared expander delay | | | 8.0 | | 10.0 | | 9.0 | ns |
| t_{PEXP} | Parallel expander delay | | | 1.0 | | 1.0 | | 2.0 | ns |
| t_{LAD} | Logic array delay | | | 6.0 | | 6.0 | | 8.0 | ns |
| t_{LAC} | Logic control array delay | | | 6.0 | | 6.0 | | 8.0 | ns |
| t_{IOE} | Internal output enable delay | (2) | | 3.0 | | — | | 4.0 | ns |
| t_{OD1} | Output buffer and pad delay Slow slew rate = off $V_{CCIO} = 5.0\text{ V}$ | $C1 = 35\text{ pF}$ | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{OD2} | Output buffer and pad delay Slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ (7) | | 5.0 | | — | | 6.0 | ns |
| t_{OD3} | Output buffer and pad delay Slow slew rate = on $V_{CCIO} = 5.0\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ (2) | | 8.0 | | — | | 9.0 | ns |
| t_{ZX1} | Output buffer enable delay Slow slew rate = off $V_{CCIO} = 5.0\text{ V}$ | $C1 = 35\text{ pF}$ | | 6.0 | | 6.0 | | 10.0 | ns |
| t_{ZX2} | Output buffer enable delay Slow slew rate = off $V_{CCIO} = 3.3\text{ V}$ | $C1 = 35\text{ pF}$ (7) | | 7.0 | | — | | 11.0 | ns |
| t_{ZX3} | Output buffer enable delay Slow slew rate = on $V_{CCIO} = 5.0\text{ V}$ or 3.3 V | $C1 = 35\text{ pF}$ (2) | | 10.0 | | — | | 14.0 | ns |
| t_{XZ} | Output buffer disable delay | $C1 = 5\text{ pF}$ | | 6.0 | | 6.0 | | 10.0 | ns |
| t_{SU} | Register setup time | | 4.0 | | 4.0 | | 4.0 | | ns |
| t_H | Register hold time | | 4.0 | | 4.0 | | 5.0 | | ns |
| t_{FSU} | Register setup time of fast input | (2) | 2.0 | | — | | 4.0 | | ns |
| t_{FH} | Register hold time of fast input | (2) | 2.0 | | — | | 3.0 | | ns |
| t_{RD} | Register delay | | | 1.0 | | 1.0 | | 1.0 | ns |
| t_{COMB} | Combinatorial delay | | | 1.0 | | 1.0 | | 1.0 | ns |
| t_{IC} | Array clock delay | | | 6.0 | | 6.0 | | 8.0 | ns |
| t_{EN} | Register enable time | | | 6.0 | | 6.0 | | 8.0 | ns |
| t_{GLOB} | Global control delay | | | 1.0 | | 1.0 | | 3.0 | ns |
| t_{PRE} | Register preset time | | | 4.0 | | 4.0 | | 4.0 | ns |
| t_{CLR} | Register clear time | | | 4.0 | | 4.0 | | 4.0 | ns |
| t_{PIA} | PIA delay | | | 2.0 | | 2.0 | | 3.0 | ns |
| t_{LPA} | Low-power adder | (8) | | 13.0 | | 15.0 | | 15.0 | ns |

Table 27. EPM7032S External Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|-------------------|--|------------|-------------|-----|-------|-----|-------|-----|-------|-----|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 175.4 | | 142.9 | | 116.3 | | 100.0 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 250.0 | | 200.0 | | 166.7 | | 125.0 | | MHz |

Table 28. EPM7032S Internal Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|------------|-----------------------------------|----------------|-------------|-----|-----|-----|-----|-----|-----|-----|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.2 | | 0.2 | | 0.3 | | 0.5 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.2 | | 0.2 | | 0.3 | | 0.5 | ns |
| t_{FIN} | Fast input delay | | | 2.2 | | 2.1 | | 2.5 | | 1.0 | ns |
| t_{SEXP} | Shared expander delay | | | 3.1 | | 3.8 | | 4.6 | | 5.0 | ns |
| t_{PEXP} | Parallel expander delay | | | 0.9 | | 1.1 | | 1.4 | | 0.8 | ns |
| t_{LAD} | Logic array delay | | | 2.6 | | 3.3 | | 4.0 | | 5.0 | ns |
| t_{LAC} | Logic control array delay | | | 2.5 | | 3.3 | | 4.0 | | 5.0 | ns |
| t_{IOE} | Internal output enable delay | | | 0.7 | | 0.8 | | 1.0 | | 2.0 | ns |
| t_{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.2 | | 0.3 | | 0.4 | | 1.5 | ns |
| t_{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 0.7 | | 0.8 | | 0.9 | | 2.0 | ns |
| t_{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.2 | | 5.3 | | 5.4 | | 5.5 | ns |
| t_{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 4.5 | | 4.5 | | 5.5 | ns |
| t_{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 9.0 | | 9.0 | ns |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 4.0 | | 4.0 | | 5.0 | ns |
| t_{SU} | Register setup time | | 0.8 | | 1.0 | | 1.3 | | 2.0 | | ns |
| t_H | Register hold time | | 1.7 | | 2.0 | | 2.5 | | 3.0 | | ns |
| t_{FSU} | Register setup time of fast input | | 1.9 | | 1.8 | | 1.7 | | 3.0 | | ns |
| t_{FH} | Register hold time of fast input | | 0.6 | | 0.7 | | 0.8 | | 0.5 | | ns |
| t_{RD} | Register delay | | | 1.2 | | 1.6 | | 1.9 | | 2.0 | ns |
| t_{COMB} | Combinatorial delay | | | 0.9 | | 1.1 | | 1.4 | | 2.0 | ns |
| t_{IC} | Array clock delay | | | 2.7 | | 3.4 | | 4.2 | | 5.0 | ns |
| t_{EN} | Register enable time | | | 2.6 | | 3.3 | | 4.0 | | 5.0 | ns |
| t_{GLOB} | Global control delay | | | 1.6 | | 1.4 | | 1.7 | | 1.0 | ns |
| t_{PRE} | Register preset time | | | 2.0 | | 2.4 | | 3.0 | | 3.0 | ns |
| t_{CLR} | Register clear time | | | 2.0 | | 2.4 | | 3.0 | | 3.0 | ns |

Table 28. EPM7032S Internal Timing Parameters *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|-----------|-----------------|------------|-------------|------|-----|------|-----|------|-----|------|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{PIA} | PIA delay | (7) | | 1.1 | | 1.1 | | 1.4 | | 1.0 | ns |
| t_{LPA} | Low-power adder | (8) | | 12.0 | | 10.0 | | 10.0 | | 11.0 | ns |

Notes to tables:

- (1) These values are specified under the recommended operating conditions shown in Table 14. See Figure 13 for more information on switching waveforms.
- (2) This minimum pulse width for preset and clear applies for both global clear and array controls. The t_{LPA} parameter must be added to this minimum width if the clear or reset signal incorporates the t_{LAD} parameter into the signal path.
- (3) This parameter is a guideline that is sample-tested only and is based on extensive device characterization. This parameter applies for both global and array clocking.
- (4) These parameters are measured with a 16-bit loadable, enabled, up/down counter programmed into each LAB.
- (5) The f_{MAX} values represent the highest frequency for pipelined data.
- (6) Operating conditions: $V_{CCIO} = 3.3\text{ V} \pm 10\%$ for commercial and industrial use.
- (7) For EPM7064S-5, EPM7064S-6, EPM7128S-6, EPM7160S-6, EPM7160S-7, EPM7192S-7, and EPM7256S-7 devices, these values are specified for a PIA fan-out of one LAB (16 macrocells). For each additional LAB fan-out in these devices, add an additional 0.1 ns to the PIA timing value.
- (8) The t_{LPA} parameter must be added to the t_{LAD} , t_{LAC} , t_{IC} , t_{EN} , t_{SEXP} , t_{ACL} , and t_{CPPW} parameters for macrocells running in the low-power mode.

Tables 29 and 30 show the EPM7064S AC operating conditions.

Table 29. EPM7064S External Timing Parameters (Part 1 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|--------|---------------------------------------|------------|-------------|-----|-----|-----|-----|-----|-----|------|------|
| | | | -5 | | -6 | | -7 | | -10 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| tPD1 | Input to non-registered output | C1 = 35 pF | | 5.0 | | 6.0 | | 7.5 | | 10.0 | ns |
| tPD2 | I/O input to non-registered output | C1 = 35 pF | | 5.0 | | 6.0 | | 7.5 | | 10.0 | ns |
| tSU | Global clock setup time | | 2.9 | | 3.6 | | 6.0 | | 7.0 | | ns |
| tH | Global clock hold time | | 0.0 | | 0.0 | | 0.0 | | 0.0 | | ns |
| tFSU | Global clock setup time of fast input | | 2.5 | | 2.5 | | 3.0 | | 3.0 | | ns |
| tFH | Global clock hold time of fast input | | 0.0 | | 0.0 | | 0.5 | | 0.5 | | ns |
| tCO1 | Global clock to output delay | C1 = 35 pF | | 3.2 | | 4.0 | | 4.5 | | 5.0 | ns |
| tCH | Global clock high time | | 2.0 | | 2.5 | | 3.0 | | 4.0 | | ns |
| tCL | Global clock low time | | 2.0 | | 2.5 | | 3.0 | | 4.0 | | ns |
| tASU | Array clock setup time | | 0.7 | | 0.9 | | 3.0 | | 2.0 | | ns |
| tAH | Array clock hold time | | 1.8 | | 2.1 | | 2.0 | | 3.0 | | ns |

Table 33. EPM7160S External Timing Parameters (Part 2 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|-------------------|--|------------|-------------|-----|-------|-----|-------|------|-------|------|------|
| | | | -6 | | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t _{ACNT} | Minimum array clock period | | | 6.7 | | 8.2 | | 10.0 | | 13.0 | ns |
| f _{ACNT} | Maximum internal array clock frequency | (4) | 149.3 | | 122.0 | | 100.0 | | 76.9 | | MHz |
| f _{MAX} | Maximum clock frequency | (5) | 166.7 | | 166.7 | | 125.0 | | 100.0 | | MHz |

Table 34. EPM7160S Internal Timing Parameters (Part 1 of 2) *Note (1)*

| Symbol | Parameter | Conditions | Speed Grade | | | | | | | | Unit |
|------------|-----------------------------------|----------------|-------------|-----|-----|-----|-----|-----|-----|------|------|
| | | | -6 | | -7 | | -10 | | -15 | | |
| | | | Min | Max | Min | Max | Min | Max | Min | Max | |
| t_{IN} | Input pad and buffer delay | | | 0.2 | | 0.3 | | 0.5 | | 2.0 | ns |
| t_{IO} | I/O input pad and buffer delay | | | 0.2 | | 0.3 | | 0.5 | | 2.0 | ns |
| t_{FIN} | Fast input delay | | | 2.6 | | 3.2 | | 1.0 | | 2.0 | ns |
| t_{SEXP} | Shared expander delay | | | 3.6 | | 4.3 | | 5.0 | | 8.0 | ns |
| t_{PEXP} | Parallel expander delay | | | 1.0 | | 1.3 | | 0.8 | | 1.0 | ns |
| t_{LAD} | Logic array delay | | | 2.8 | | 3.4 | | 5.0 | | 6.0 | ns |
| t_{LAC} | Logic control array delay | | | 2.8 | | 3.4 | | 5.0 | | 6.0 | ns |
| t_{IOE} | Internal output enable delay | | | 0.7 | | 0.9 | | 2.0 | | 3.0 | ns |
| t_{OD1} | Output buffer and pad delay | C1 = 35 pF | | 0.4 | | 0.5 | | 1.5 | | 4.0 | ns |
| t_{OD2} | Output buffer and pad delay | C1 = 35 pF (6) | | 0.9 | | 1.0 | | 2.0 | | 5.0 | ns |
| t_{OD3} | Output buffer and pad delay | C1 = 35 pF | | 5.4 | | 5.5 | | 5.5 | | 8.0 | ns |
| t_{ZX1} | Output buffer enable delay | C1 = 35 pF | | 4.0 | | 4.0 | | 5.0 | | 6.0 | ns |
| t_{ZX2} | Output buffer enable delay | C1 = 35 pF (6) | | 4.5 | | 4.5 | | 5.5 | | 7.0 | ns |
| t_{ZX3} | Output buffer enable delay | C1 = 35 pF | | 9.0 | | 9.0 | | 9.0 | | 10.0 | ns |
| t_{XZ} | Output buffer disable delay | C1 = 5 pF | | 4.0 | | 4.0 | | 5.0 | | 6.0 | ns |
| t_{SU} | Register setup time | | 1.0 | | 1.2 | | 2.0 | | 4.0 | | ns |
| t_H | Register hold time | | 1.6 | | 2.0 | | 3.0 | | 4.0 | | ns |
| t_{FSU} | Register setup time of fast input | | 1.9 | | 2.2 | | 3.0 | | 2.0 | | ns |
| t_{FH} | Register hold time of fast input | | 0.6 | | 0.8 | | 0.5 | | 1.0 | | ns |
| t_{RD} | Register delay | | | 1.3 | | 1.6 | | 2.0 | | 1.0 | ns |
| t_{COMB} | Combinatorial delay | | | 1.0 | | 1.3 | | 2.0 | | 1.0 | ns |
| t_{IC} | Array clock delay | | | 2.9 | | 3.5 | | 5.0 | | 6.0 | ns |
| t_{EN} | Register enable time | | | 2.8 | | 3.4 | | 5.0 | | 6.0 | ns |
| t_{GLOB} | Global control delay | | | 2.0 | | 2.4 | | 1.0 | | 1.0 | ns |
| t_{PRE} | Register preset time | | | 2.4 | | 3.0 | | 3.0 | | 4.0 | ns |

Table 39. MAX 7000 I_{CC} Equation Constants

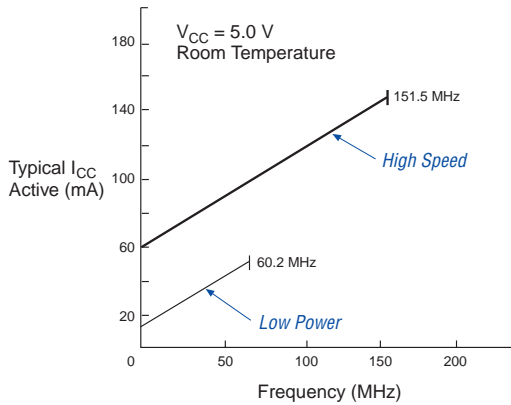
| Device | A | B | C |
|----------|------|------|-------|
| EPM7032 | 1.87 | 0.52 | 0.144 |
| EPM7064 | 1.63 | 0.74 | 0.144 |
| EPM7096 | 1.63 | 0.74 | 0.144 |
| EPM7128E | 1.17 | 0.54 | 0.096 |
| EPM7160E | 1.17 | 0.54 | 0.096 |
| EPM7192E | 1.17 | 0.54 | 0.096 |
| EPM7256E | 1.17 | 0.54 | 0.096 |
| EPM7032S | 0.93 | 0.40 | 0.040 |
| EPM7064S | 0.93 | 0.40 | 0.040 |
| EPM7128S | 0.93 | 0.40 | 0.040 |
| EPM7160S | 0.93 | 0.40 | 0.040 |
| EPM7192S | 0.93 | 0.40 | 0.040 |
| EPM7256S | 0.93 | 0.40 | 0.040 |

This calculation provides an I_{CC} estimate based on typical conditions using a pattern of a 16-bit, loadable, enabled, up/down counter in each LAB with no output load. Actual I_{CC} values should be verified during operation because this measurement is sensitive to the actual pattern in the device and the environmental operating conditions.

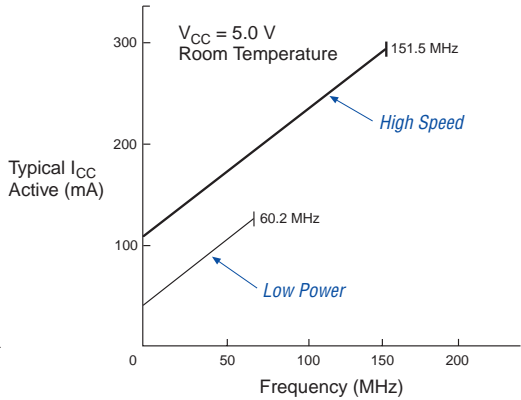
Figure 14 shows typical supply current versus frequency for MAX 7000 devices.

Figure 14. I_{CC} vs. Frequency for MAX 7000 Devices (Part 1 of 2)

EPM7032



EPM7064



EPM7096

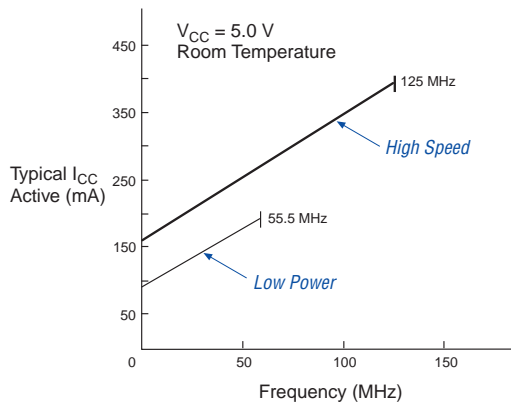
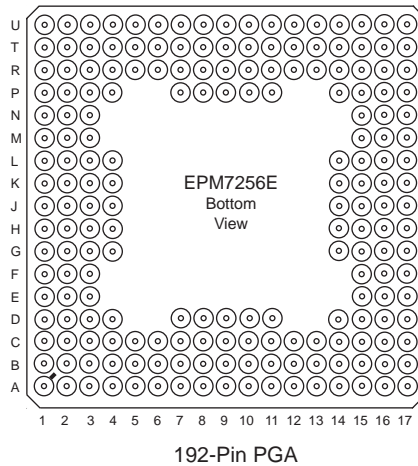
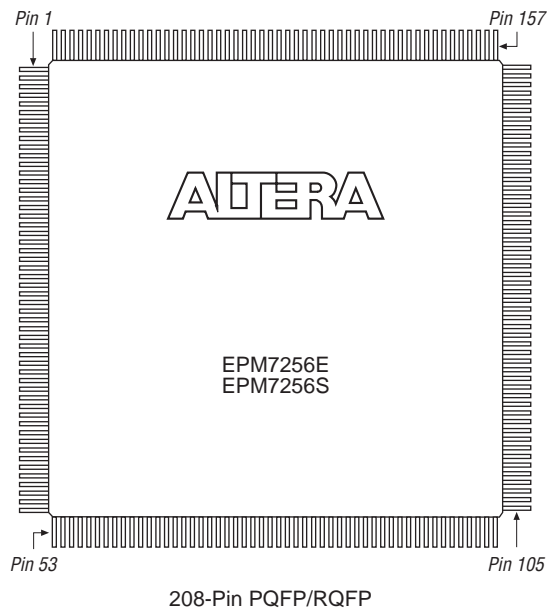


Figure 21. 192-Pin Package Pin-Out Diagram

Package outline not drawn to scale.

**Figure 22. 208-Pin Package Pin-Out Diagram**

Package outline not drawn to scale.



Revision History

The information contained in the *MAX 7000 Programmable Logic Device Family Data Sheet* version 6.7 supersedes information published in previous versions. The following changes were made in the *MAX 7000 Programmable Logic Device Family Data Sheet* version 6.7:

Version 6.7

The following changes were made in the *MAX 7000 Programmable Logic Device Family Data Sheet* version 6.7:

- Reference to *AN 88: Using the Jam Language for ISP & ICR via an Embedded Processor* has been replaced by *AN 122: Using Jam STAPL for ISP & ICR via an Embedded Processor*.

Version 6.6

The following changes were made in the *MAX 7000 Programmable Logic Device Family Data Sheet* version 6.6:

- Added [Tables 6](#) through [8](#).
- Added “[Programming Sequence](#)” section on [page 17](#) and “[Programming Times](#)” section on [page 18](#).

Version 6.5

The following changes were made in the *MAX 7000 Programmable Logic Device Family Data Sheet* version 6.5:

- Updated text on [page 16](#).

Version 6.4

The following changes were made in the *MAX 7000 Programmable Logic Device Family Data Sheet* version 6.4:

- Added [Note \(5\)](#) on [page 28](#).

Version 6.3

The following changes were made in the *MAX 7000 Programmable Logic Device Family Data Sheet* version 6.3:

- Updated the “[Open-Drain Output Option \(MAX 7000S Devices Only\)](#)” section on [page 20](#).



Notes: